

APPLICATION DATA SHEET**Inventor Information**

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Application Information

Title : APPARATUSES FOR MAKING AND USING BI-MODAL
ABRASIVE SLURRIES FOR MECHANICAL AND
CHEMICAL-MECHANICAL PLANARIZATION OF
MICROELECTRONIC-DEVICE SUBSTRATE
ASSEMBLIES
Total Drawing Sheets : 5
Formal Drawings : YES
Application Type : Utility
Attorney Docket Number : 500155.07
Assigned : Yes (Large Entity)

Representative Information

Representative Customer No. : 27,076

Continuity Information

This application is a : divisional of

>Application One : 10/155,203
Filing Date : May 23, 2002
which is a : continuation of
>>Application Two : 09/289,790
Filing Date : April 9, 1999
Patent Number : 6,407,000

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